# NTST20120CTG, NTSJ20120CTG, NTSB20120CT-1G, NTSB20120CTG, NTSB20120CTT4G

## Very Low Forward Voltage Trench-based Schottky Rectifier

## Exceptionally Low $V_F = 0.54$ V at $I_F = 5$ A

### Features

- Fine Lithography Trench–based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- These are Pb–Free Devices

### **Typical Applications**

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC–DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

### **Mechanical Characteristics**

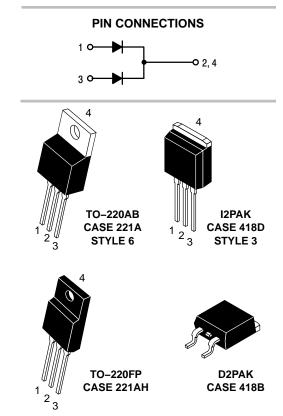
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec



## **ON Semiconductor®**

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VERY LOW FORWARD VOLTAGE, LOW LEAKAGE SCHOTTKY BARRIER RECTIFIERS 20 AMPERES, 120 VOLTS



### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

# NTST20120CTG, NTSJ20120CTG, NTSB20120CT–1G, NTSB20120CTG, NTSB20120CTT4G

### MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	120	V
Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = $130^{\circ}$ C)	Per device Per diode	I <sub>F(AV)</sub>	20 10	A
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 135^{\circ}C$ )	Per device Per diode	I <sub>FRM</sub>	40 20	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I <sub>FSM</sub>	120	A
Operating Junction Temperature		TJ	-40 to +150	°C
Storage Temperature		T <sub>stg</sub>	-40 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )		dv/dt	10,000	V/μs

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### THERMAL CHARACTERISTICS

Rating	Symbol	NTST20120CTG NTSB20120CT-1G	NTSB20120CTG	NTSJ20120CTG	Unit
Maximum Thermal Resistance per Diode Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	2.5 70	1.43 46.8	4.42 105	°C/W °C/W

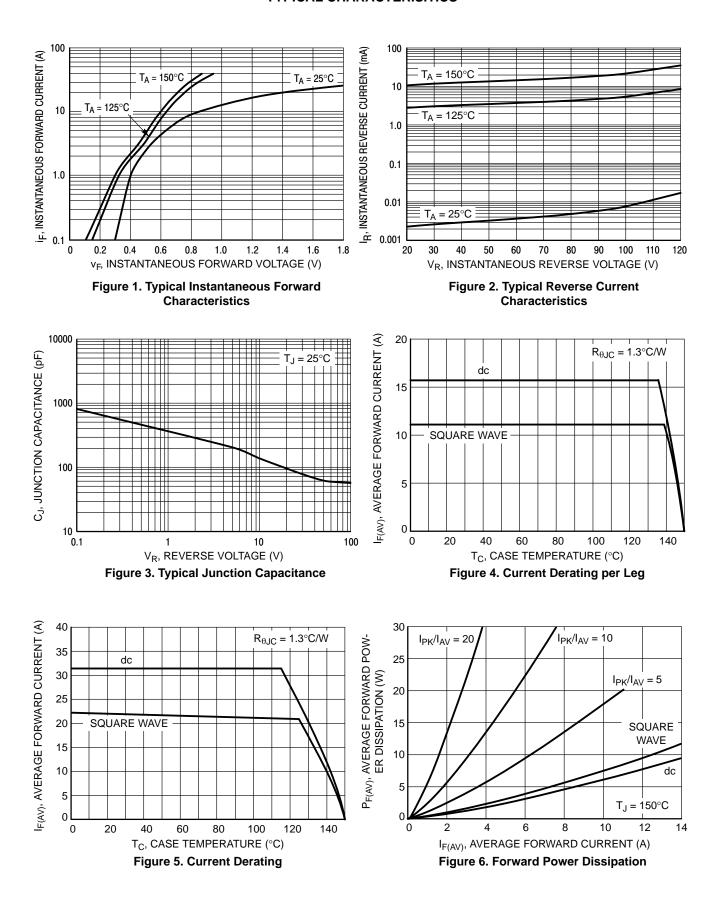
### ELECTRICAL CHARACTERISTICS (Per Leg unless otherwise noted)

Rating	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1) ( $I_F = 5 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $I_F = 10 \text{ A}, T_J = 25^{\circ}\text{C}$ )	VF	0.62 0.90	_ 1.10	V
(I <sub>F</sub> = 5 A, T <sub>J</sub> = 125°C) (I <sub>F</sub> = 10 A, T <sub>J</sub> = 125°C)		0.54 0.64	_ 0.72	
Maximum Instantaneous Reverse Current (Note 1) ( $V_R = 90 \text{ V}, T_J = 25^{\circ}\text{C}$ ) ( $V_R = 90 \text{ V}, T_J = 125^{\circ}\text{C}$ )	۱ <sub>R</sub>	12 6		μA mA
(Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 125^{\circ}C$ )		- 17	700 100	μA mA

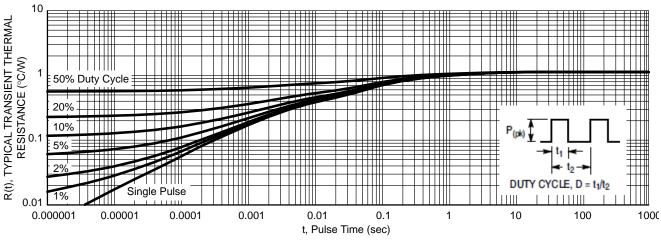
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq 2.0\%$ 

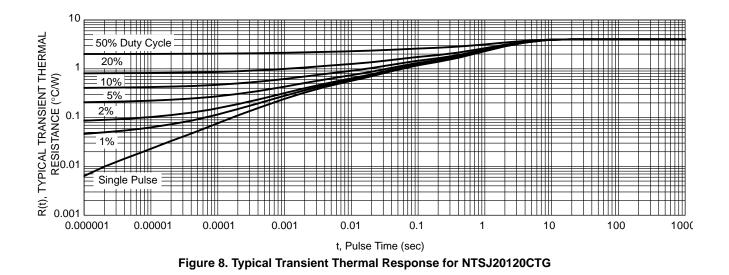
### NTST20120CTG, NTSJ20120CTG, NTSB20120CT-1G, NTSB20120CTG, NTSB20120CTT4G TYPICAL CHARACTERISITICS

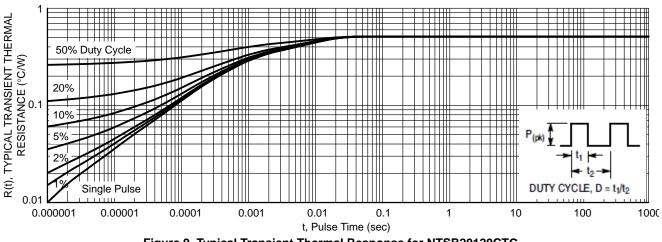


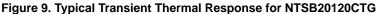
### NTST20120CTG, NTSJ20120CTG, NTSB20120CT-1G, NTSB20120CTG, NTSB20120CTT4G **TYPICAL CHARACTERISITICS**











# NTST20120CTG, NTSJ20120CTG, NTSB20120CT–1G, NTSB20120CTG, NTSB20120CTT4G

### **ORDERING INFORMATION**

Device	Package	Shipping
NTST20120CTG	TO-220AB (Pb-Free)	50 Units / Rail
NTSJ20120CTG	TO-220FP 50 Units / Rail (Halide-Free)	
NTSB20120CT-1G	l <sup>2</sup> PAK (Pb–Free)	50 Units / Rail
NTSB20120CTG	D <sup>2</sup> PAK (Pb–Free)	50 Units / Rail
NTSB20120CTT4G	D <sup>2</sup> PAK (Pb–Free)	800 / Tape & Reel

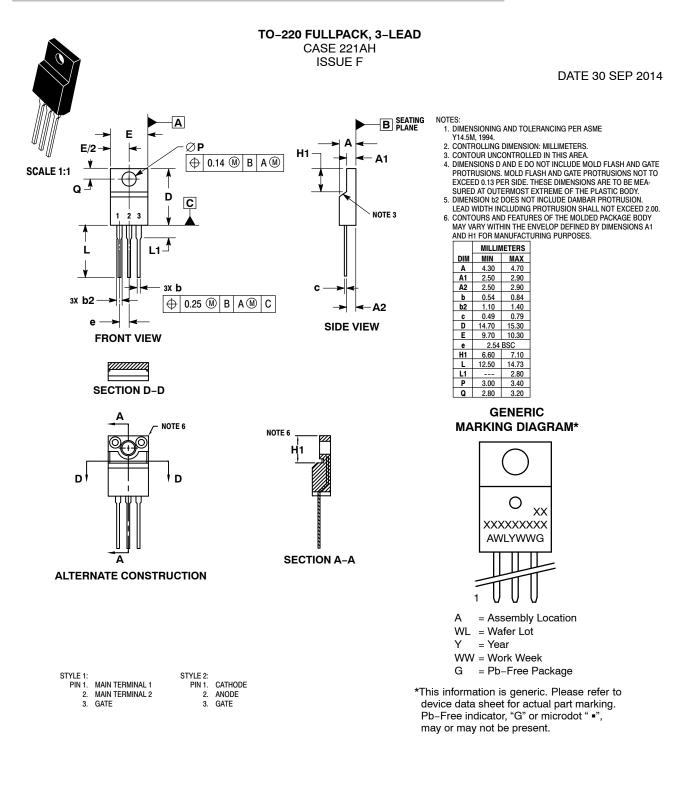
### AYWW AYWW TS20120CG AYWW AYWW TS20120CG TS20120Cx TS20120CG AKA AKA AKA AKA 1 11 $\overline{1}$ TO-220FP I<sup>2</sup>PAK D<sup>2</sup>PAK TO-220AB

MARKING DIAGRAMS

A = ASSEMBLY LOCATION	А	= Assembly Location
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- Υ = Year
- WW = Work Week
- AKA = Polarity Designator
- х = G or H
- = Pb-Free Package G
- н = Halide-Free Package

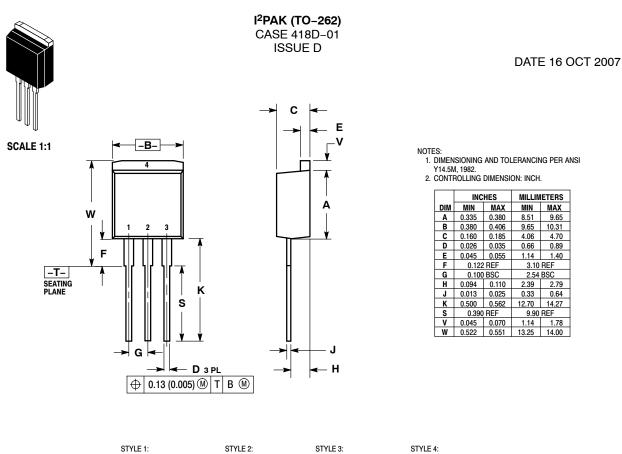




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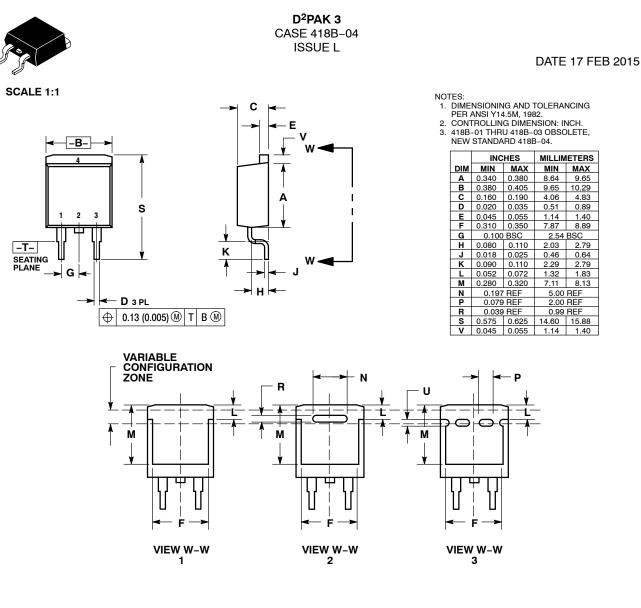


STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:	
PIN 1.	BASE	PIN 1.	GATE	PIN 1.	ANODE	PIN 1.	GATE
2.	COLLECTOR	2.	DRAIN	2.	CATHODE	2.	COLLECTOR
3.	EMITTER	3.	SOURCE	3.	ANODE	3.	EMITTER
4.	COLLECTOR	4.	DRAIN	4.	CATHODE	4.	COLLECTOR

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STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. GATE	PIN 1. CATHODE	PIN 1. NO CONNECT
2. COLLECTOR	2. DRAIN	2. CATHODE	2. COLLECTOR	2. ANODE	2. CATHODE
3. EMITTER	<ol><li>SOURCE</li></ol>	<ol><li>ANODE</li></ol>	3. EMITTER	<ol><li>CATHODE</li></ol>	3. ANODE
4. COLLECTOR	4. DRAIN	4. CATHODE	4. COLLECTOR	4. ANODE	4. CATHODE

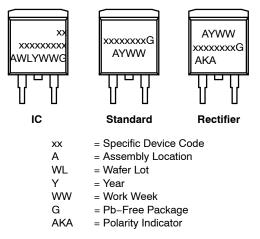
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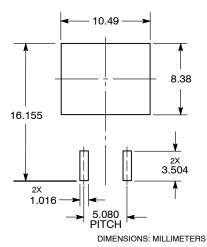
### DATE 17 FEB 2015

### GENERIC MARKING DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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